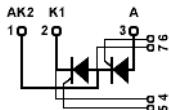
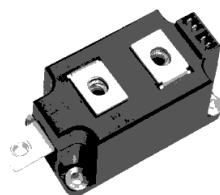


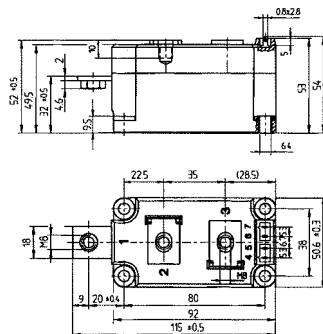
# STT253

## Thyristor-Thyristor Modules



Type	$V_{RSM}$ $V_{DSM}$	$V_{RRM}$ $V_{DRM}$
	V	V
STT253GK08	900	800
STT253GK12	1300	1200
STT253GK14	1500	1400
STT253GK16	1700	1600
STT253GK18	1900	1800

Dimensions in mm (1mm=0.0394")



Symbol	Test Conditions	Maximum Ratings	Unit
$I_{TRMS}$ , $I_{FRMS}$ $I_{TAVM}$ , $I_{FAVM}$	$T_{VJ}=T_{VJM}$ $T_c=85^\circ C$ ; 180° sine	400 253	A
$I_{TSM}$ , $I_{FSM}$	$T_{VJ}=45^\circ C$ $V_R=0$	8500 9000	A
	$T_{VJ}=T_{VJM}$ $V_R=0$	7000 8000	
$\int i^2 dt$	$T_{VJ}=45^\circ C$ $V_R=0$	405000 336000	$A^2 s$
	$T_{VJ}=T_{VJM}$ $V_R=0$	320000 240000	
$(di/dt)_{cr}$	$T_{VJ}=T_{VJM}$ $f=50Hz$ , $t_p=200\mu s$ $V_D=2/3V_{DRM}$ $I_G=1A$ $di/dt=1A/\mu s$	250 800	A/us
	non repetitive, $I_T=250A$		
$(dv/dt)_{cr}$	$T_{VJ}=T_{VJM}$ ; $V_{DR}=2/3V_{DRM}$ $R_{GK}=\infty$ ; method 1 (linear voltage rise)	1000	V/us
$P_{GM}$	$T_{VJ}=T_{VJM}$ $I_T=I_{TAVM}$	120 60	W
$P_{GAV}$		20	W
$V_{RGM}$		10	V
$T_{VJ}$ $T_{VJM}$ $T_{stg}$		-40...+140 140 -40...+130	°C
$V_{ISOL}$	50/60Hz, RMS $I_{ISOL}\leq 1mA$	3000 3600	V~
$M_d$	Mounting torque (M5) Terminal connection torque (M8)	2.5-5/22-44 12-15/106-132	Nm/lb.in.
<b>Weight</b>	Typical including screws	430	g

# STT253

## Thyristor-Thyristor Modules

Symbol	Test Conditions	Characteristic Values	Unit
$I_{RRM}$	$T_{VJ}=T_{VJM}$ ; $V_R=V_{RRM}$ ; $V_D=V_{DRM}$	70	mA
$I_{DRM}$		40	mA
$V_T, V_F$	$I_T, I_F=750A$ ; $T_{VJ}=25^\circ C$	1.7	V
$V_{TO}$	For power-loss calculations only ( $T_{VJ}=140^\circ C$ )	0.85	V
$r_T$		1.1	$m\Omega$
$V_{GT}$	$V_D=6V$ ; $T_{VJ}=25^\circ C$ $T_{VJ}=-40^\circ C$	2 3	V
$I_{GT}$	$V_D=6V$ ; $T_{VJ}=25^\circ C$ $T_{VJ}=-40^\circ C$	150 200	mA
$V_{GD}$	$T_{VJ}=T_{VJM}$ ; $V_D=2/3V_{DRM}$	0.25	V
$I_{GD}$		10	mA
$I_L$	$T_{VJ}=25^\circ C$ ; $t_p=30\mu s$ ; $V_D=6V$ $I_G=0.45A$ ; $dI/dt=0.45A/\mu s$	300	mA
$I_H$	$T_{VJ}=25^\circ C$ ; $V_D=6V$ ; $R_{GK}=\infty$	150	mA
$t_{gd}$	$T_{VJ}=25^\circ C$ ; $V_D=1/2V_{DRM}$ $I_G=1A$ ; $dI/dt=1A/\mu s$	2	us
$t_q$	$T_{VJ}=T_{VJM}$ ; $I_T=300A$ ; $t_p=200\mu s$ ; $-dI/dt=10A/\mu s$ $V_R=100V$ ; $dV/dt=50V/\mu s$ ; $V_D=2/3V_{DRM}$	typ. 200	us
$Q_s$	$T_{VJ}=125^\circ C$ ; $I_T, I_F=400A$ ; $-dI/dt=50A/\mu s$	760	uC
$I_{RM}$		275	A
$R_{thJC}$	per thyristor/diode; DC current per module	0.129 0.0645	K/W
$R_{thJK}$	per thyristor/diode; DC current per module	0.169 0.0845	K/W
$ds$	Creeping distance on surface	12.7	mm
$da$	Strike distance through air	9.6	mm
$a$	Maximum allowable acceleration	50	$m/s^2$

### FEATURES

- \* International standard package
- \* Direct copper bonded Al<sub>2</sub>O<sub>3</sub>-ceramic base plate
- \* Planar passivated chips
- \* Isolation voltage 3600 V~

### APPLICATIONS

- \* Motor control
- \* Power converter
- \* Heat and temperature control for industrial furnaces and chemical processes
- \* Lighting control
- \* Contactless switches

### ADVANTAGES

- \* Space and weight savings
- \* Simple mounting
- \* Improved temperature and power cycling
- \* Reduced protection circuits



# STT253

## Thyristor-Thyristor Modules

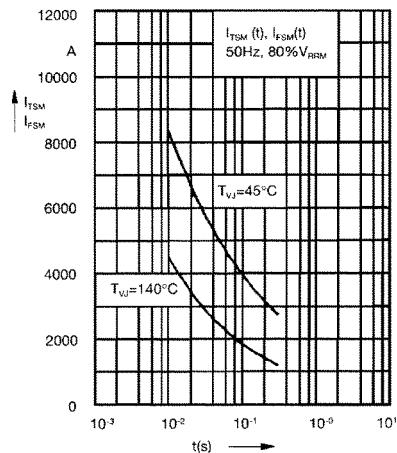


Fig. 1 Surge overload current  
 $I_{TSM}, I_{FSM}$ : Crest value, t: duration

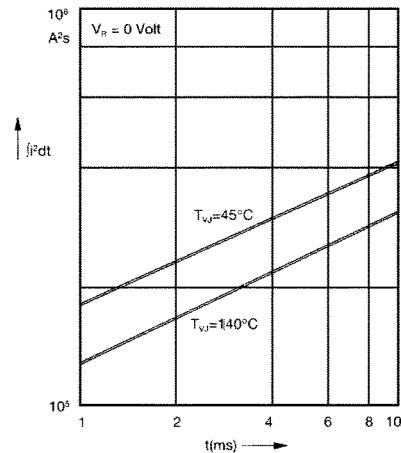


Fig. 2  $\int i^2 dt$  versus time (1-10 ms)

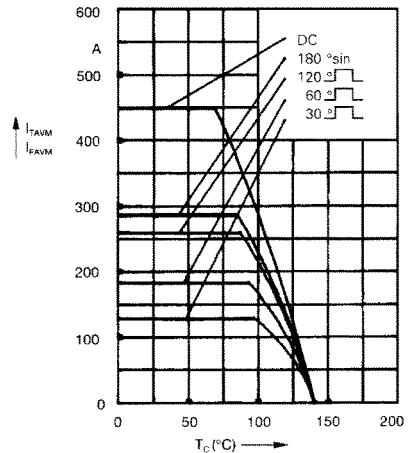


Fig. 2a Maximum forward current  
at case temperature

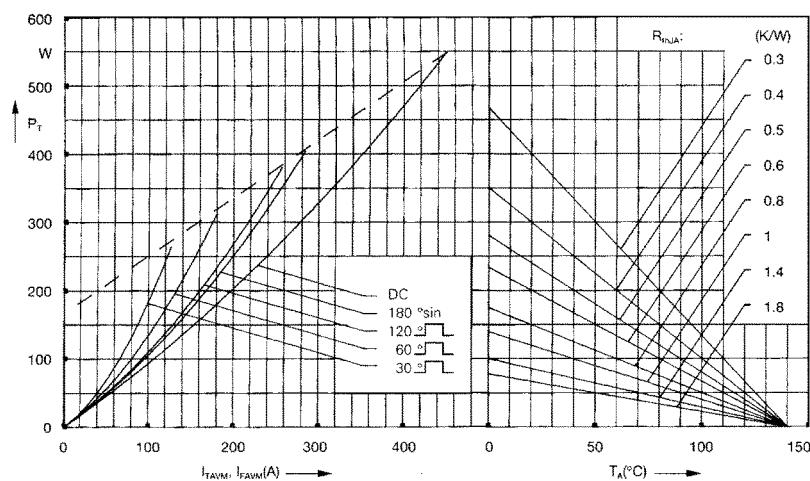


Fig. 3 Power dissipation versus on-state current and ambient temperature  
(per thyristor or diode)

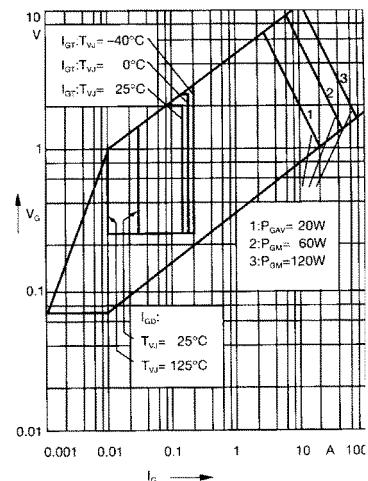


Fig. 4 Gate trigger characteristics

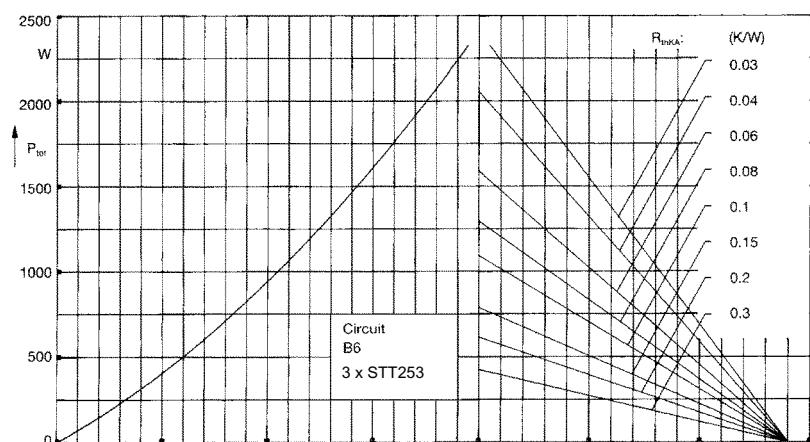


Fig. 5 Three phase rectifier bridge: Power dissipation versus direct output current  
and ambient temperature

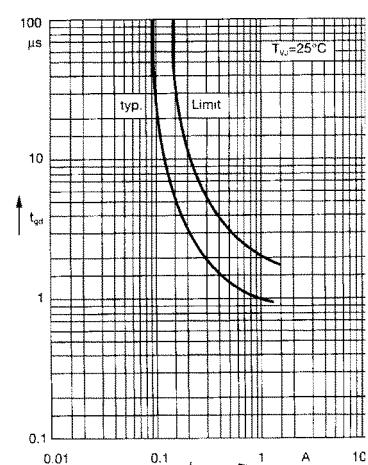


Fig. 6 Gate trigger delay time

# STT253

## Thyristor-Thyristor Modules

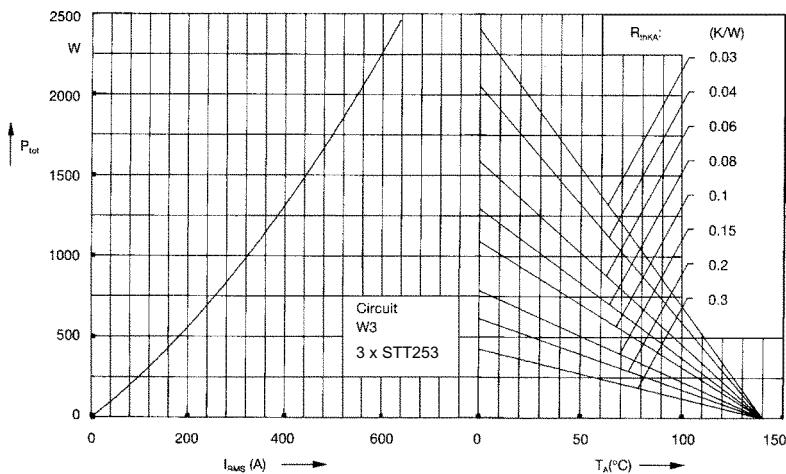


Fig. 7 Three phase AC-controller:  
Power dissipation versus RMS  
output current and ambient  
temperature

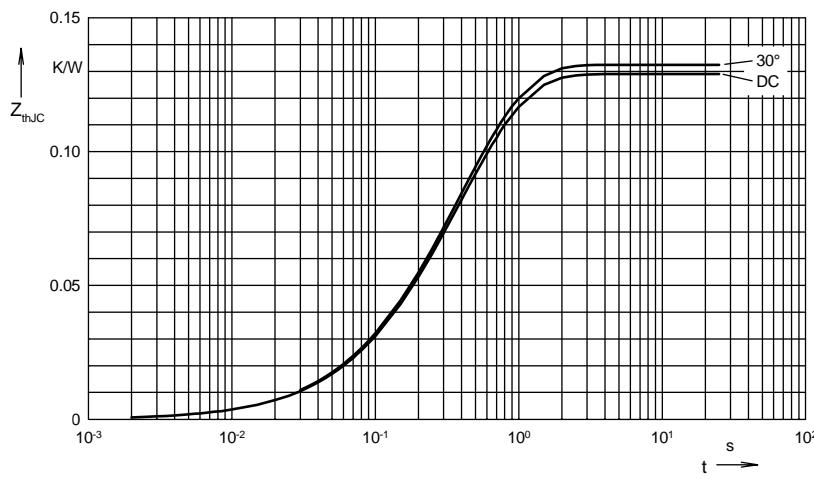


Fig. 8 Transient thermal impedance  
junction to case (per thyristor or  
diode)

d	$R_{thJC}$ (K/W)
DC	0.129
180°	0.131
120°	0.131
60°	0.132
30°	0.132

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0035	0.099
2	0.0165	0.168
3	0.1091	0.456

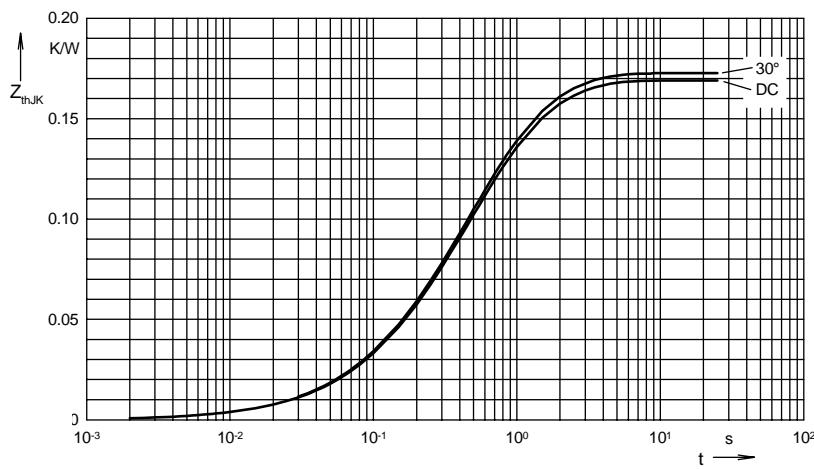


Fig. 9 Transient thermal impedance  
junction to heatsink (per thyristor  
or diode)

d	$R_{thJK}$ (K/W)
DC	0.169
180°	0.171
120°	0.172
60°	0.172
30°	0.173

Constants for  $Z_{thJK}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.0033	0.099
2	0.0159	0.168
3	0.1053	0.456
4	0.04	1.36